USB-C DFP + 5V2A Power Bank With Input Fast Charger Reference Design

Designed for: Public Release

Assembly Variant: 001

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Revision History

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Place Block Diagram here (if appropriate) or delete this text box. If using a block diagram from another tool, save the picture as a .bmp file. Then, use menu Place|Drawing Tools|Graphic to insert the .png/.svg/.bmp file on the schematic.

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Version control disabled

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PMP11536
Number:
Rev:
TID #:
PM11536
Orderable:
N/A
## Label Table

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### Assembly Notes
- **ZZ1**: ESD sensitive, ESD precautions shall be observed.
- **ZZ2**: Must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- **ZZ3**: Must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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